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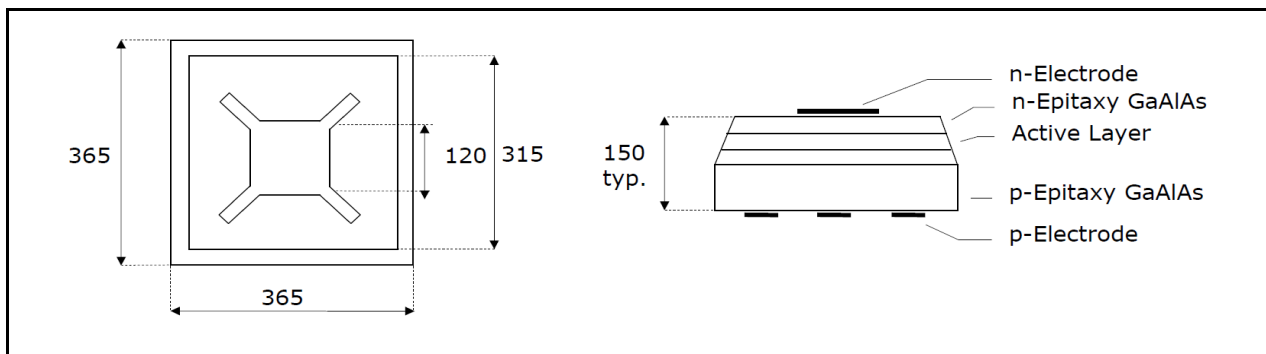
Data Sheet

LED Chip Infrared

EOLC-800-27

Rev. 03, 2017

Radiation	Type	Electrodes
Infrared	AlGaAs/AlGaAs, DDH	N (cathode) up



Chip thickness 150±30 μm; anode and cathode - Au alloy.

Optical and Electrical Characteristics

T_{amb} = 25°C, unless otherwise specified

Parameter	Test cond.	Symbol	Min	Typ	Max	Unit
Forward voltage	I _F =20 mA	V _F		1.6	1.9	V
Reverse voltage	I _R =100 μA	V _R	5			V
Radiant power*	I _F =20 mA	Φ _e	3	4		mW
Peak wavelength	I _F =20 mA	λ _p	790	800	810	nm
FWHM	I _F =20 mA	Δλ _{0.5}		29		nm
Switching time	I _F =20 mA	t _r , t _f		45; 30		ns

*Measured on bare chip on TO-18 header

Packing

Chips on adhesive film with wire bond side up

Art. No. 113 104



We reserve the right to make changes to improve technical design and may do so without further notice. Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer.